

Title (en)

FLUIDIC INTERCONNECT, INTERCONNECT MANIFOLD AND MICROFLUIDIC DEVICES FOR INTERNAL DELIVERY OF GASES AND APPLICATION OF VACUUM

Title (de)

HYDROMECHANISCHE VERBINDUNG, VERBINDUNG VON VERTEILERN UND MIKROFLUIDISCHEN GERÄTEN ZUR INTERNEN BEREITSTELLUNG VON GASEN UND VAKUUMANWENDUNGEN

Title (fr)

SYSTEME D'INTERCONNEXION POUR FLUIDES, TUBULURE D'INTERCONNEXION ET DISPOSITIFS MICROFLUIDIQUES DESTINES A LA DISTRIBUTION INTERNE DE GAZ ET A L'APPLICATION D'UN VIDE

Publication

**EP 1242813 A4 20021030 (EN)**

Application

**EP 00953737 A 20000728**

Priority

- US 0020698 W 20000728
- US 14602399 P 19990728

Abstract (en)

[origin: WO0109598A1] Interconnect configurations and an interconnect manifold for microfluidic devices (6) is provided. Devices for introducing one or more gases or removing gases from microfluidic cavity elements (8) is also provided. The invention is also directed to methods for making interconnects and to methods for delivery or removal of gasses from microfluidic devices (6).

IPC 1-7

**G01N 27/26**; **F16L 35/00**; **B01L 3/00**; **F15C 5/00**

IPC 8 full level

**B01L 3/00** (2006.01); **F16L 39/00** (2006.01); **G01N 27/447** (2006.01)

CPC (source: EP)

**B01L 3/502715** (2013.01); **B01L 3/502723** (2013.01); **B01L 3/565** (2013.01); **F16L 39/00** (2013.01); **G01N 27/44791** (2013.01); **B01J 2219/00783** (2013.01); **B01J 2219/00813** (2013.01); **B01J 2219/00833** (2013.01); **B01J 2219/00891** (2013.01); **B01J 2219/00898** (2013.01); **B01J 2219/00907** (2013.01); **B01L 3/502707** (2013.01); **B01L 2200/027** (2013.01); **B01L 2200/0689** (2013.01); **B01L 2300/0681** (2013.01); **B01L 2300/0816** (2013.01); **B01L 2300/0874** (2013.01); **B01L 2300/0887** (2013.01); **B01L 2400/0421** (2013.01); **B01L 2400/049** (2013.01)

Citation (search report)

- [E] US 6319476 B1 20011120 - VICTOR JR RICHARD L [US], et al
- See references of WO 0109598A1

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)

**WO 0109598 A1 20010208**; EP 1242813 A1 20020925; EP 1242813 A4 20021030; JP 2003506679 A 20030218

DOCDB simple family (application)

**US 0020698 W 20000728**; EP 00953737 A 20000728; JP 2001514558 A 20000728